

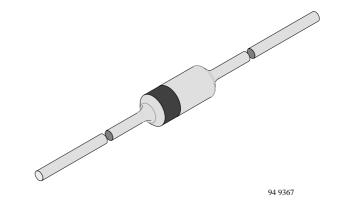
Switching Diode

Features

• Silicon Epitaxial Planar Diodes

Applications

General purposes



Order Instruction

Туре	Type Differentiation	Ordering Code	Remarks	
BAV17	V 25 V	BAV17–TAP	Ammopack	
	V _{RRM} = 25 V	BAV17–TR	Tape and Reel	
BAV18	V 60 V	BAV18–TAP	Ammopack	
	$V_{RRM} = 60 \text{ V}$	BAV18-TR	Tape and Reel	
BAV19	V _{RRM} = 120 V	BAV19-TAP	Ammopack	
		BAV19-TR	Tape and Reel	
BAV20	V _{RRM} = 200 V	BAV20-TAP	Ammopack	
		BAV20-TR	Tape and Reel	
BAV21	V 250 V	BAV21–TAP	Ammopack	
	V _{RRM} = 250 V	BAV21-TR	Tape and Reel	

Absolute Maximum Ratings

 $T_i = 25^{\circ}C$

Parameter	Test Conditions	Type	Symbol	Symbol Value	
		BAV17		25	V
		BAV18		60	V
Peak reverse voltage		BAV19	V_{RRM}	120	V
		BAV20		200	V
		BAV21		250	V
		BAV17		20	V
		BAV18		50	V
Reverse voltage		BAV19	V_R	100	V
		BAV20		150	V
		BAV21		200	V
Forward current			I _F	250	mA
Peak forward surge current	t _p =1s, T _j =25° C		I _{FSM}	1	Α
Forward peak current	f=50Hz		I _{FM}	625	mA
Junction temperature			T _i	175	°C
Storage temperature range			T _{stg}	<i>−</i> 65+175	°C

BAV17...BAV21

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Maximum Thermal Resistance

 $T_j = 25^{\circ}C$

Parameter	Test Conditions	Symbol	Value	Unit
Junction ambient	I=4 mm, T _L =constant	R_{thJA}	350	K/W

Electrical Characteristics

 $T_i = 25^{\circ}C$

Parameter	Test Conditions	Туре	Symbol	Min	Тур	Max	Unit
Forward voltage	I _F =100mA		V _F			1	V
Reverse current	V _R =20 V	BAV17	I _R			100	nA
	V _R =50 V	BAV18	I _R			100	nA
	V _R =100 V	BAV19	I _R			100	nA
	V _R =150 V	BAV20	I _R			100	nA
	V _R =200 V	BAV21	I _R			100	nA
	T _i =100 °C, V _R = 20 V	BAV17	I _R			15	μΑ
	T _j =100 °C, V _R = 50 V	BAV18	I _R			15	μΑ
	T _j =100 °C, V _R =100 V	BAV19	I_R			15	μΑ
	T _j =100 °C, V _R =150 V	BAV20	I _R			15	μΑ
	T _j =100 °C, V _R =200 V	BAV21	I _R			15	μΑ
Breakdown voltage	$I_R=100\mu A$, $t_p/T=0.01$, $t_p=0.3$ ms	BAV17	V _(BR)	25			V
		BAV18	V _(BR)	60			V
		BAV19	V _(BR)	120			V
		BAV20	V _(BR)	200			V
		BAV21	V _(BR)	250			V
Diode capacitance	V _R =0, f=1MHz		C _D		1.5		рF
Differential forward resistance	I _F =10mA		r _f		5		Ω
Reverse recovery time	$I_F=I_R=30$ mA, $I_R=3$ mA, $I_L=100$ Ω		t _{rr}			50	ns



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Characteristics $(T_j = 25^{\circ}C \text{ unless otherwise specified})$

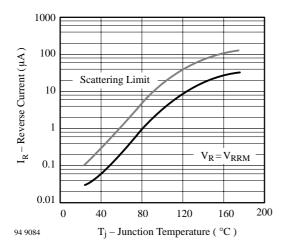


Figure 1. Reverse Current vs. Junction Temperature

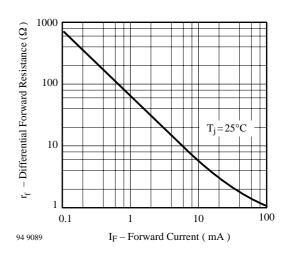


Figure 3. Differential Forward Resistance vs. Forward Current

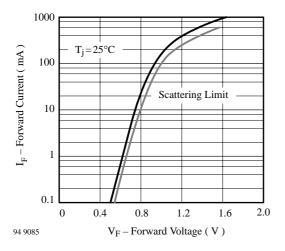
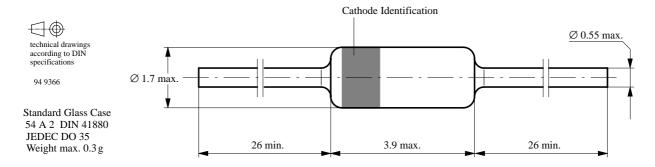


Figure 2. Forward Current vs. Forward Voltage

Dimensions in mm



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Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice. Parameters can vary in different applications. All operating parameters must be validated for each customer application

by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay-Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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